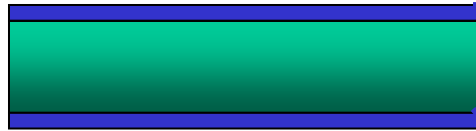


DUPLEXERS

Abstract: Phone performance using CDMA protocols (CDMA-2000 and WCDMA) is strongly dominated by the choice of those components closest to the antenna. The first component after the antenna (on the phone side) is the duplexer. The duplexer separates the transmit frequencies of the phone (output power up to about 1 Watt) from the incoming receive frequencies (as low as -110 dBm or 10^{-11} Watts). As the first component after the antenna, the duplexer has perhaps the biggest influence on the radio performance of the phone. Traditionally, bulky ceramic duplexers (made large to get high Q) were the only technology capable of meeting the phone specs. This has changed with the introduction of FBAR technology -- FBAR technology with the revolutionary microcap wafer-to-wafer bond package technology. Besides having the best specs due to the high Q, tolerance to high input power, the "all-silicon" package filter die are the smallest filters in the world. This talk will cover the FBAR performance and why it is so good, as well as an overview of microcap wafer-to-wafer hermetic "all-silicon" package.

What is a Thin Film Resonator (TFR): FBAR

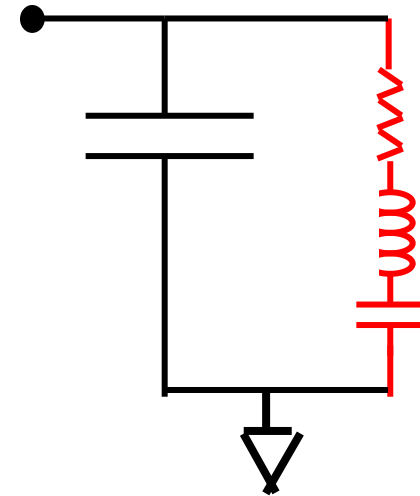
Physical Representation



Thin Film Bulk-Wave Acoustic Resonator

FBAR

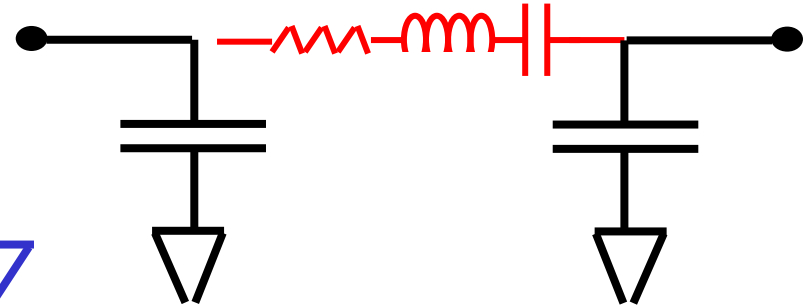
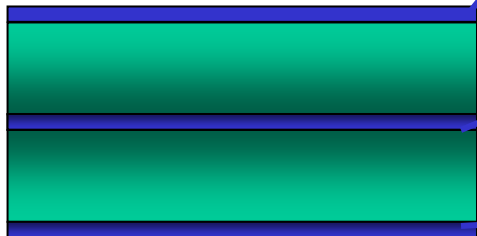
Electrical Analog



One Port Resonator

Stacked Thin Film Bulk-Wave Acoustic Resonator

SBAR



Two Port Resonator

Physics of FBAR Resonators I

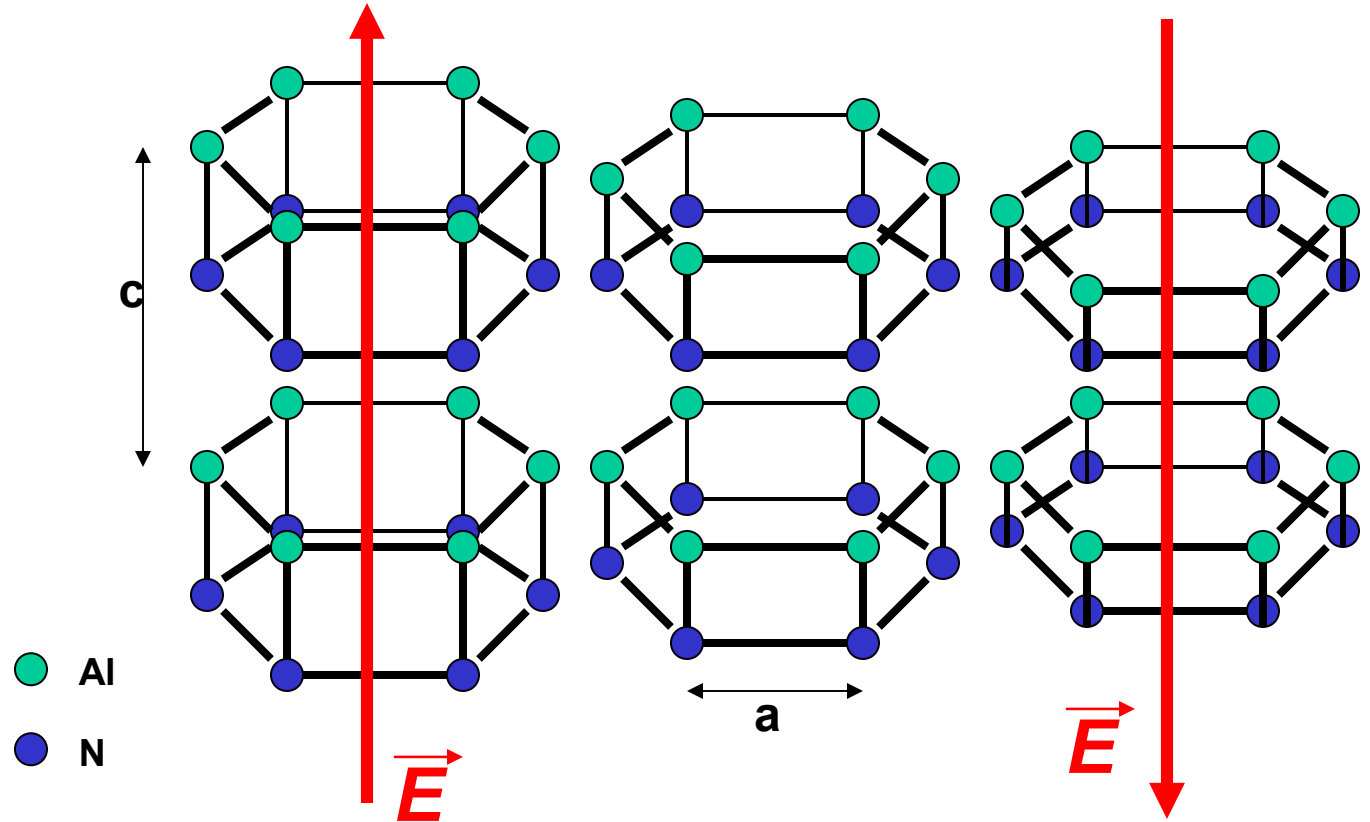
Unit Cell:

Wurtzite Structure

$a = 3.111 \text{ \AA}$

$c = 4.98 \text{ \AA}$

$\langle 002 \rangle$ Orientation



Constitutive Equations (1D)

$$D = \epsilon_r E + e S$$

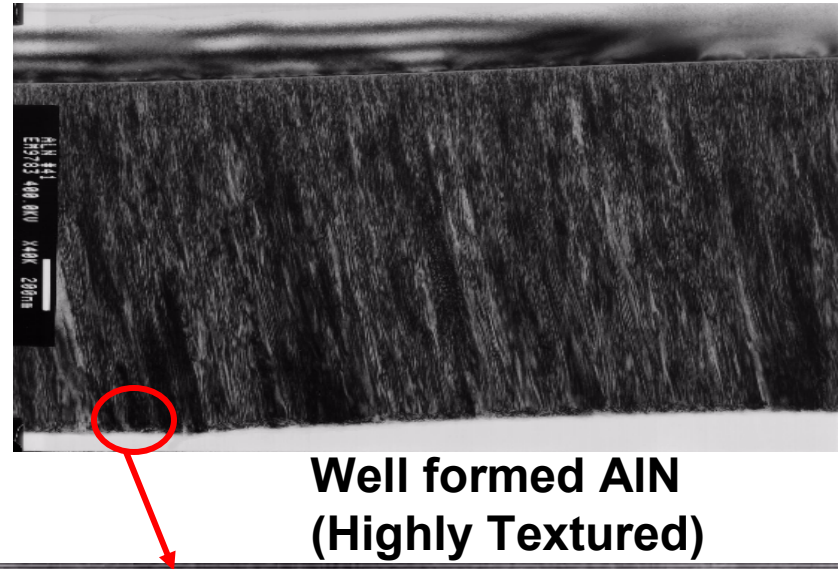
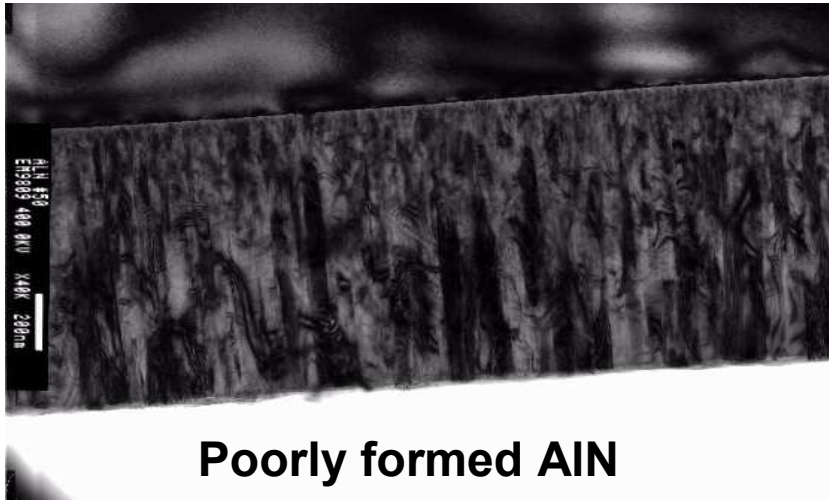
$$T = c S - e E$$

S = Strain; T = Stress; E = E field

e = piezoelectric Stress Constant

ϵ_r = relative dielectric constant

Physics of FBAR Resonators II

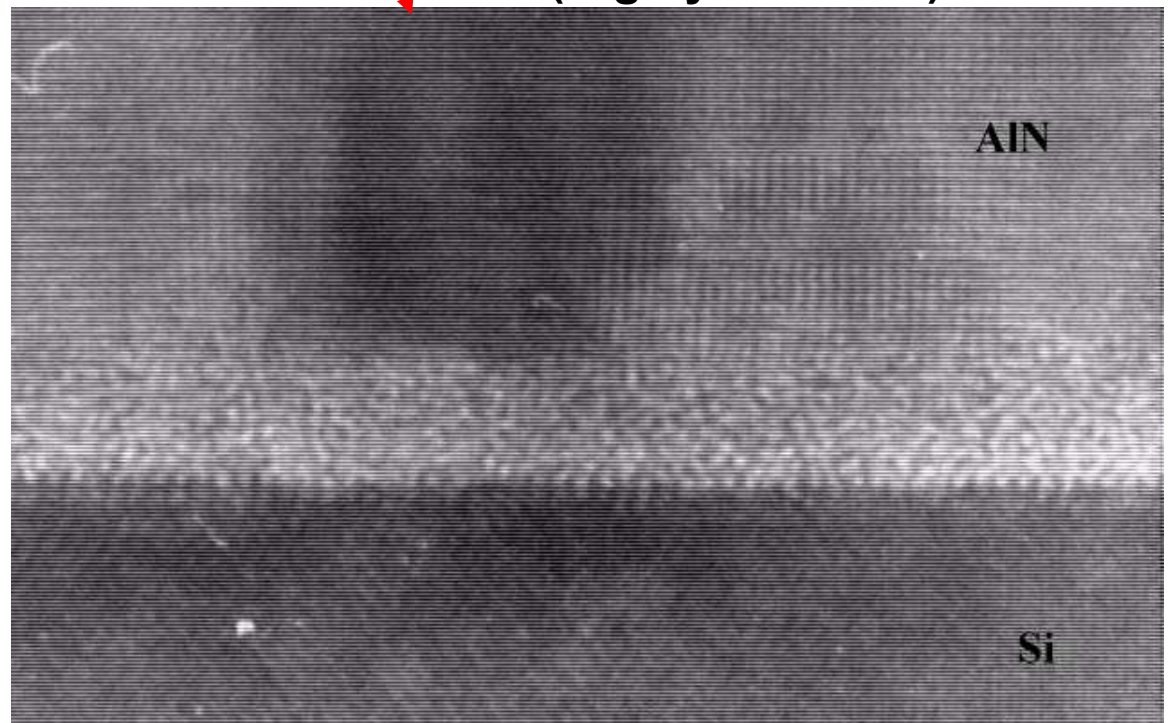


GrainSize: 30 - 50 nm

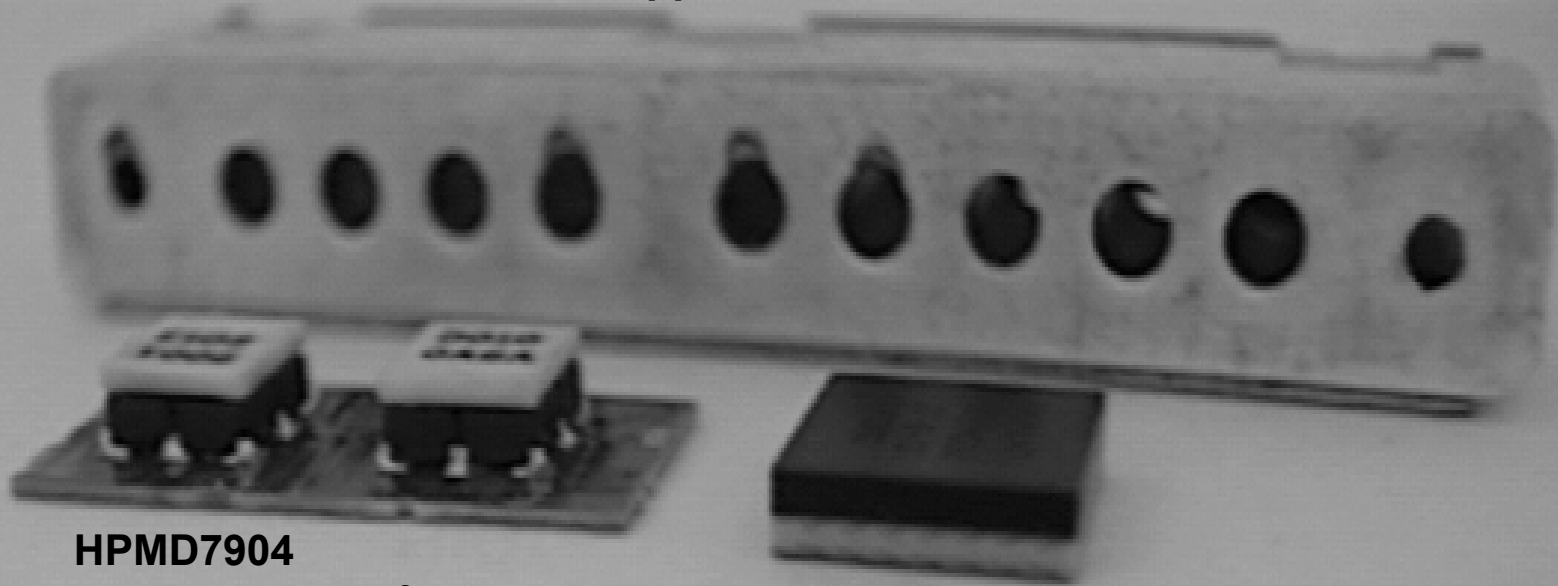
Aspect Ratio: 40 to 1

%<002>: ~100%

%Flipped Domains: ~5%



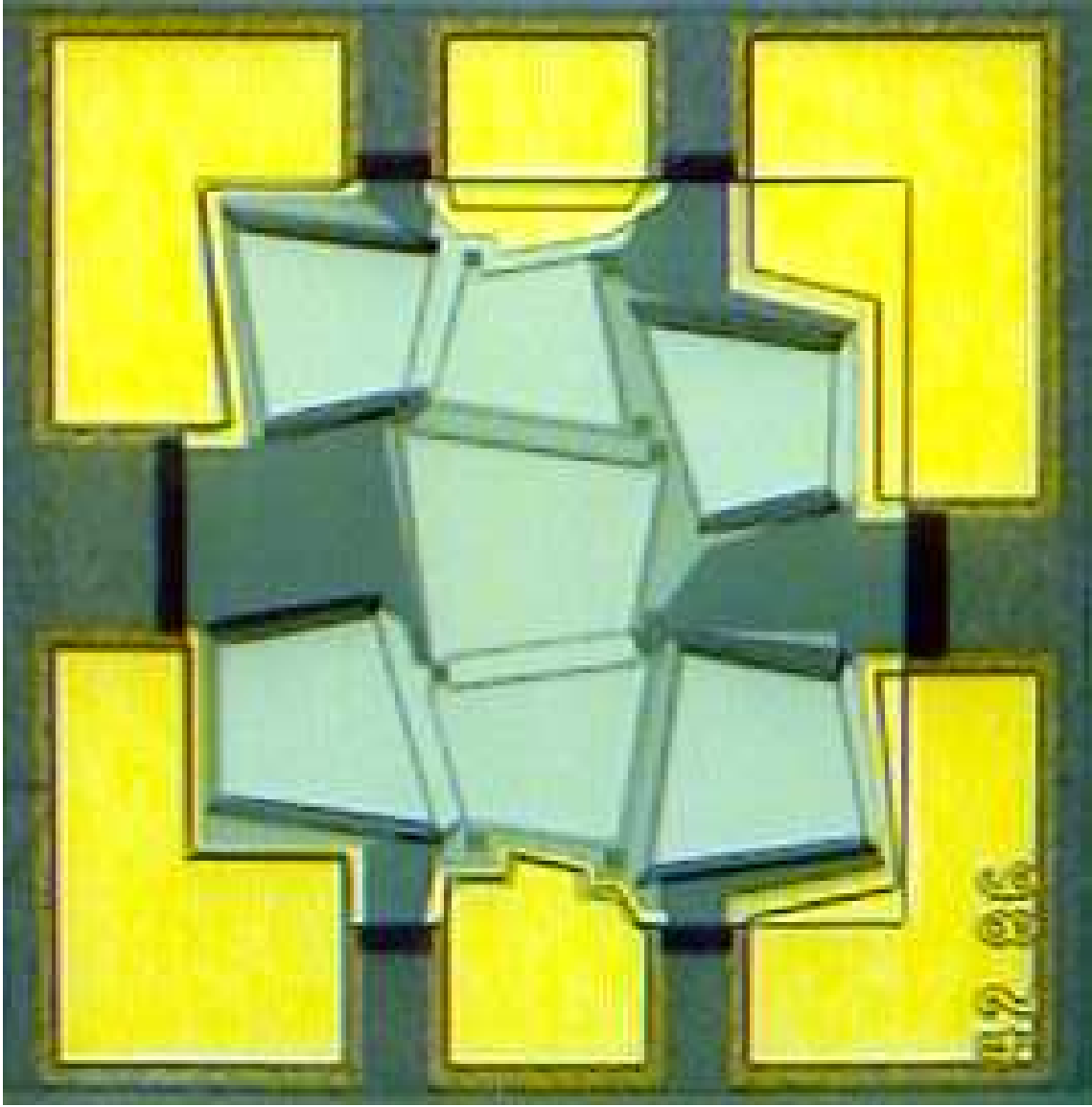
Ceramic Duplexer
Approx. 28 X 10 X 5 mm³



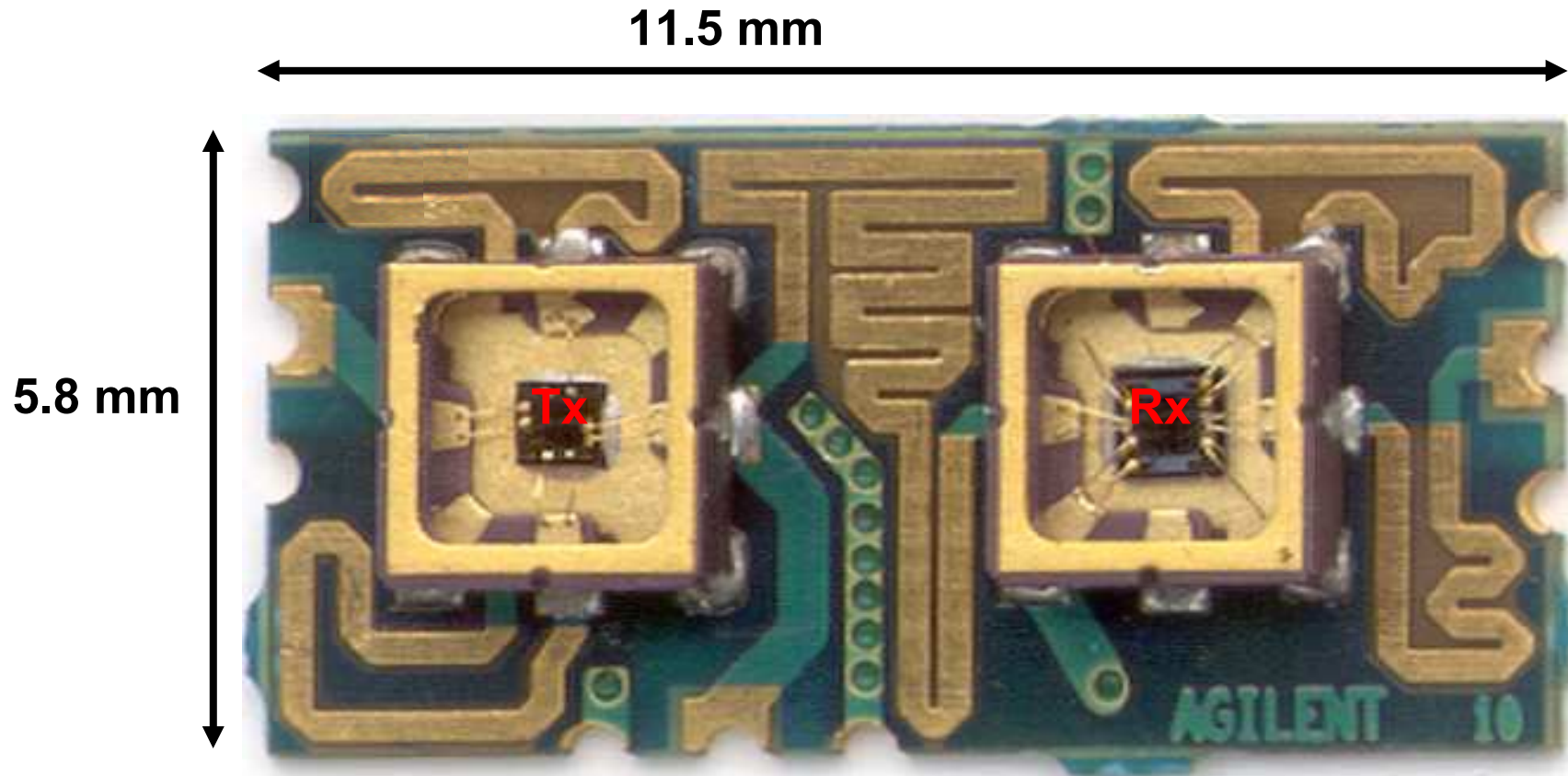
HPMD7904
6 X 12 X 1.6 mm³

Agilent's newest duplexer
~~**5 X 5 X 1 mm³**~~

3.8 x 3.8 X 1 mm³



US PCS 1900 MHz Duplexer

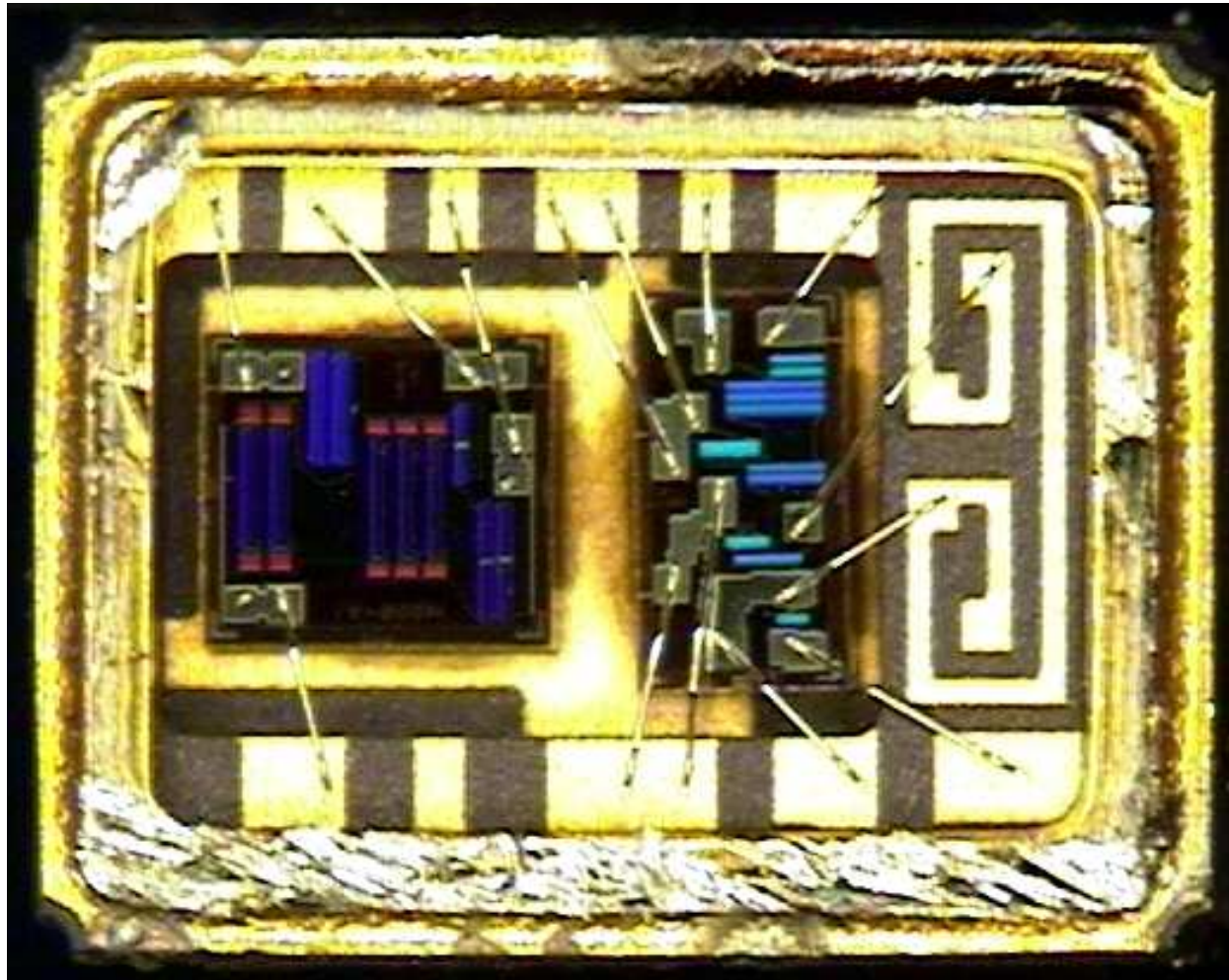


1.8 mm height

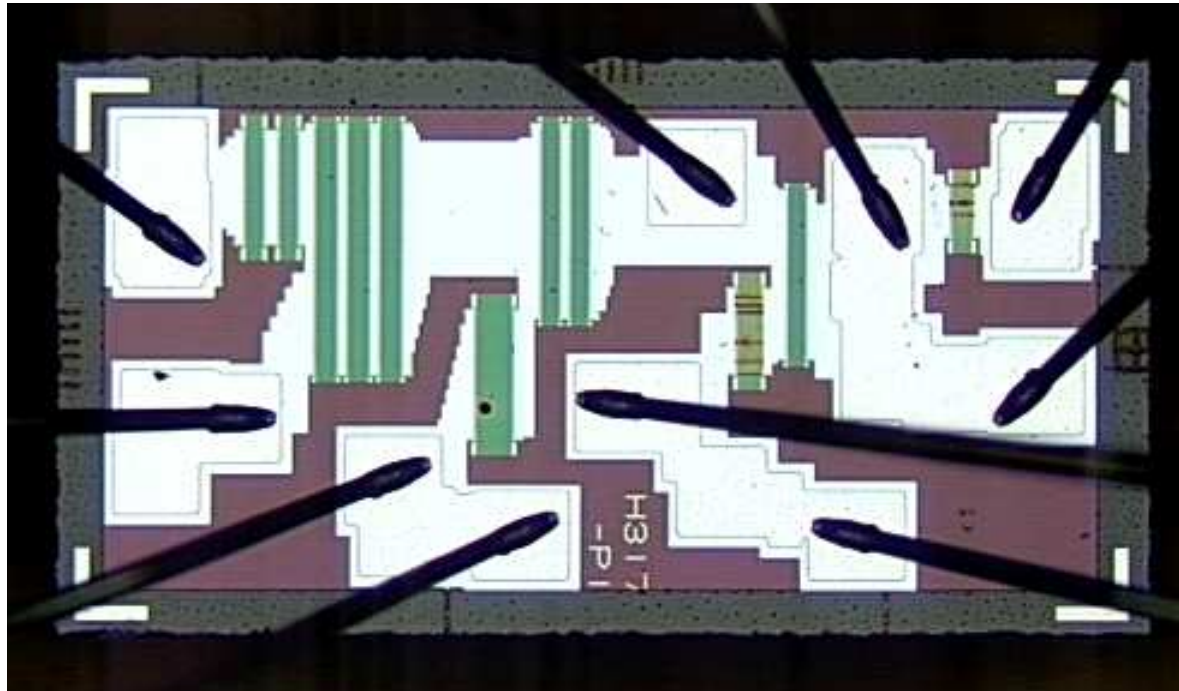
HPMD-7904

Two LCC packages (Lids removed)

Overall IC's Photo After Decapsulation



Die Size Measurement
Photo at 50X



775 um

1485 um

FBAR Conclusions

- **FBAR is a Bulk Device → This leads to**

High Q

“Intrinsic” coupling coefficient

Excellent Power handling abilities

In contrast,

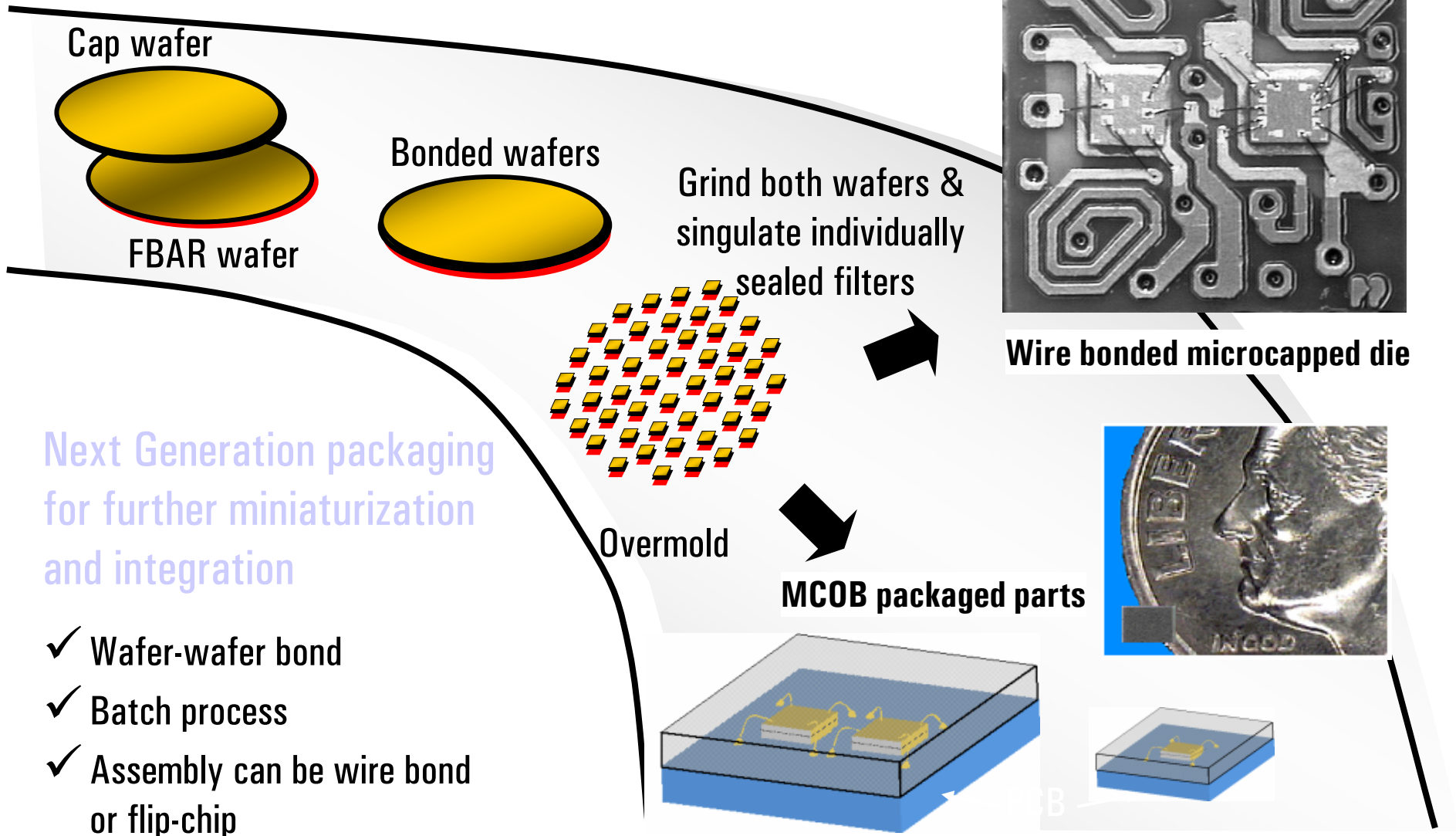
- **SAW devices are surface devices → This leads to**

Issues of Q

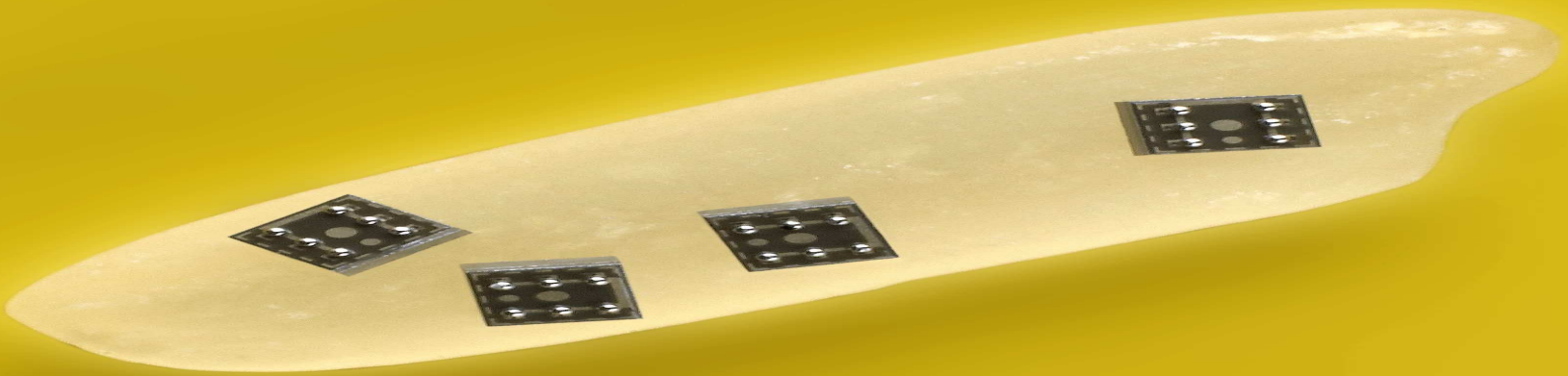
Issues of ESD

Issues of power handling

Microcap Packaging



Four Microcap'd FBAR Filters on a Grain of Rice



Microcap'd FBAR Conclusions

- **FBAR lends itself to an “all-silicon” package**

Brings packaging into fab → helps spread costs

Encourages die “shrink” → wafer + package cost the same, regardless of 10,000 die or 20,000 die on a wafer

Ultra Small Size

Compatible with silicon IC chips

In contrast,

- **SAW devices are built on LiTiO₃**

Issues of TCE

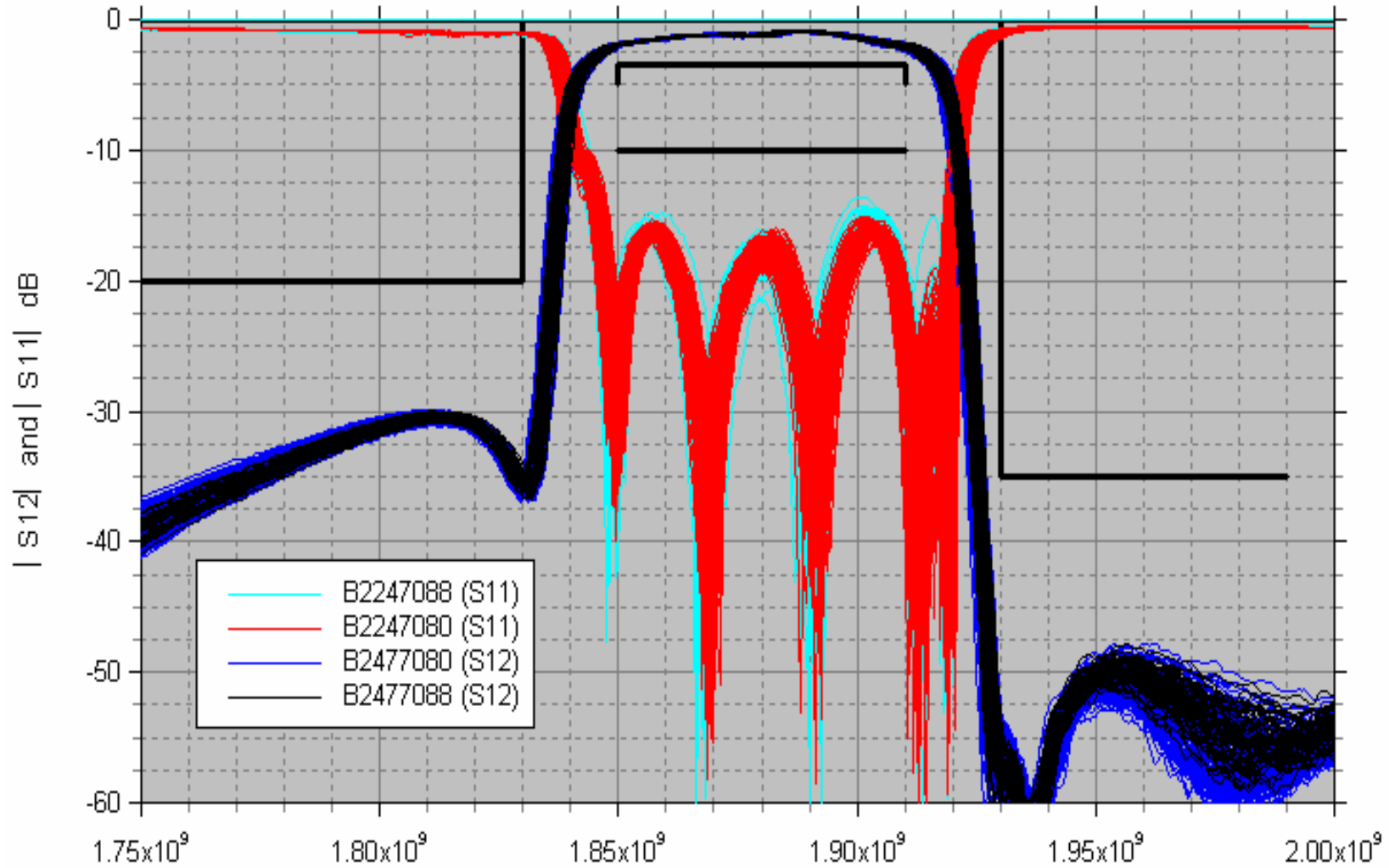
Issues of size and shrinkage

Issues of package cost

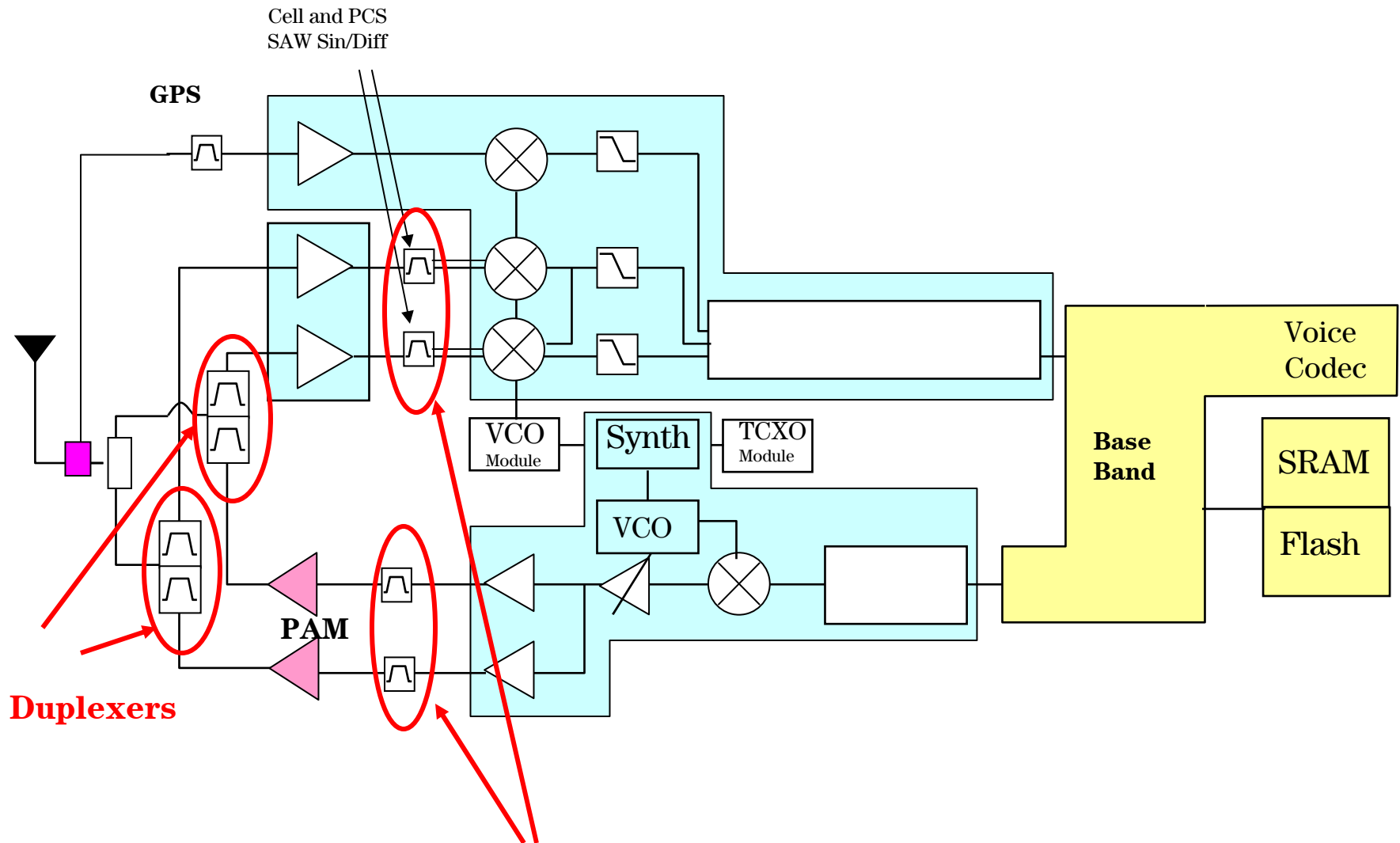
Issues of future integration

Narrow band performance from 2 MPV wafers (400 units)

Incredible Performance – not so “incredible” prices



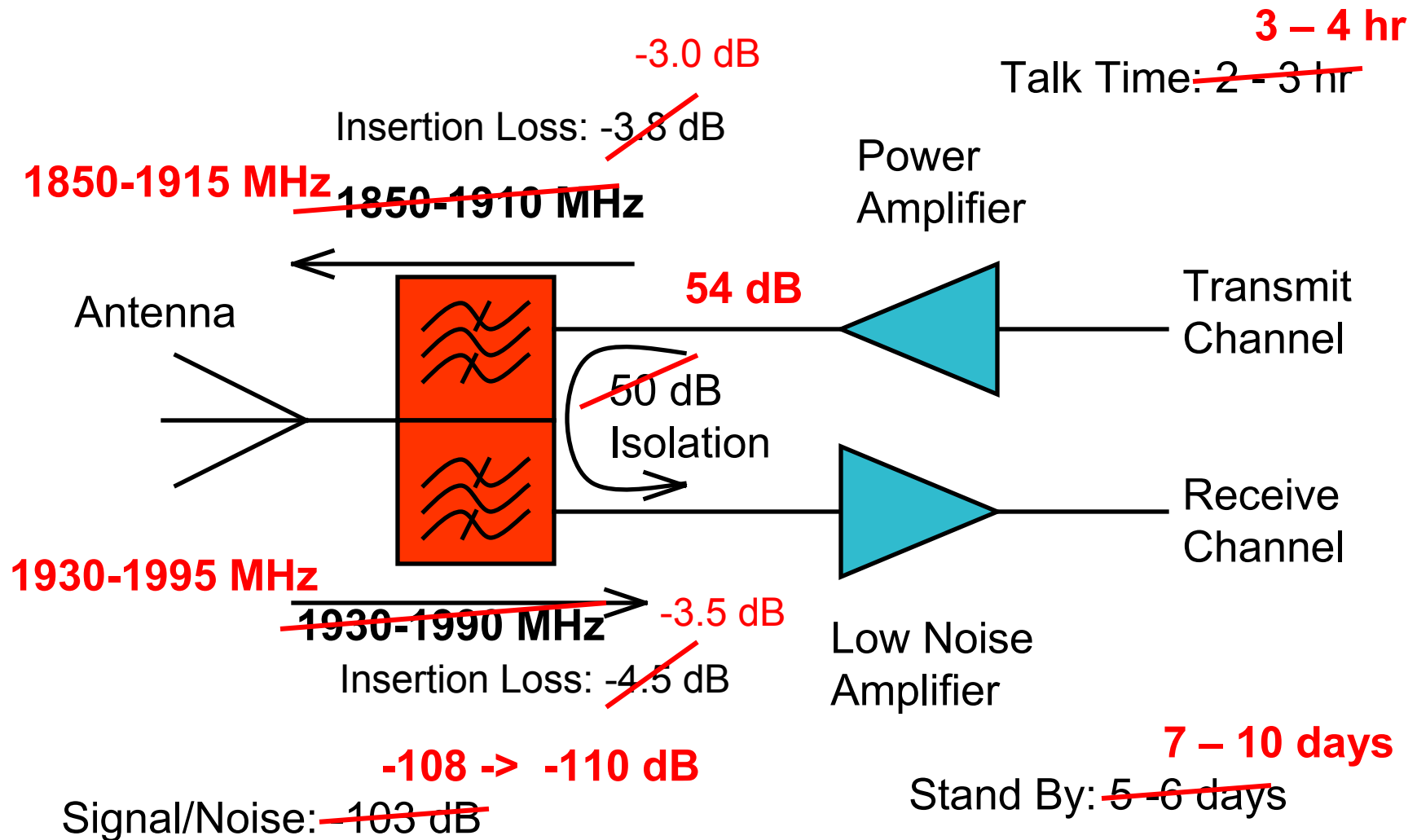
CDMA Block Diagram -- "Point" Filters



Rx and Tx "Point" Filters in CDMA Architecture

1900 MHz CDMA Handset Duplexer

The “bar” keeps getting raised!



Note: “Intennas”, GPS, PTT, Camera/flash, PDA have since been added at the same time, phones have gotten smaller!

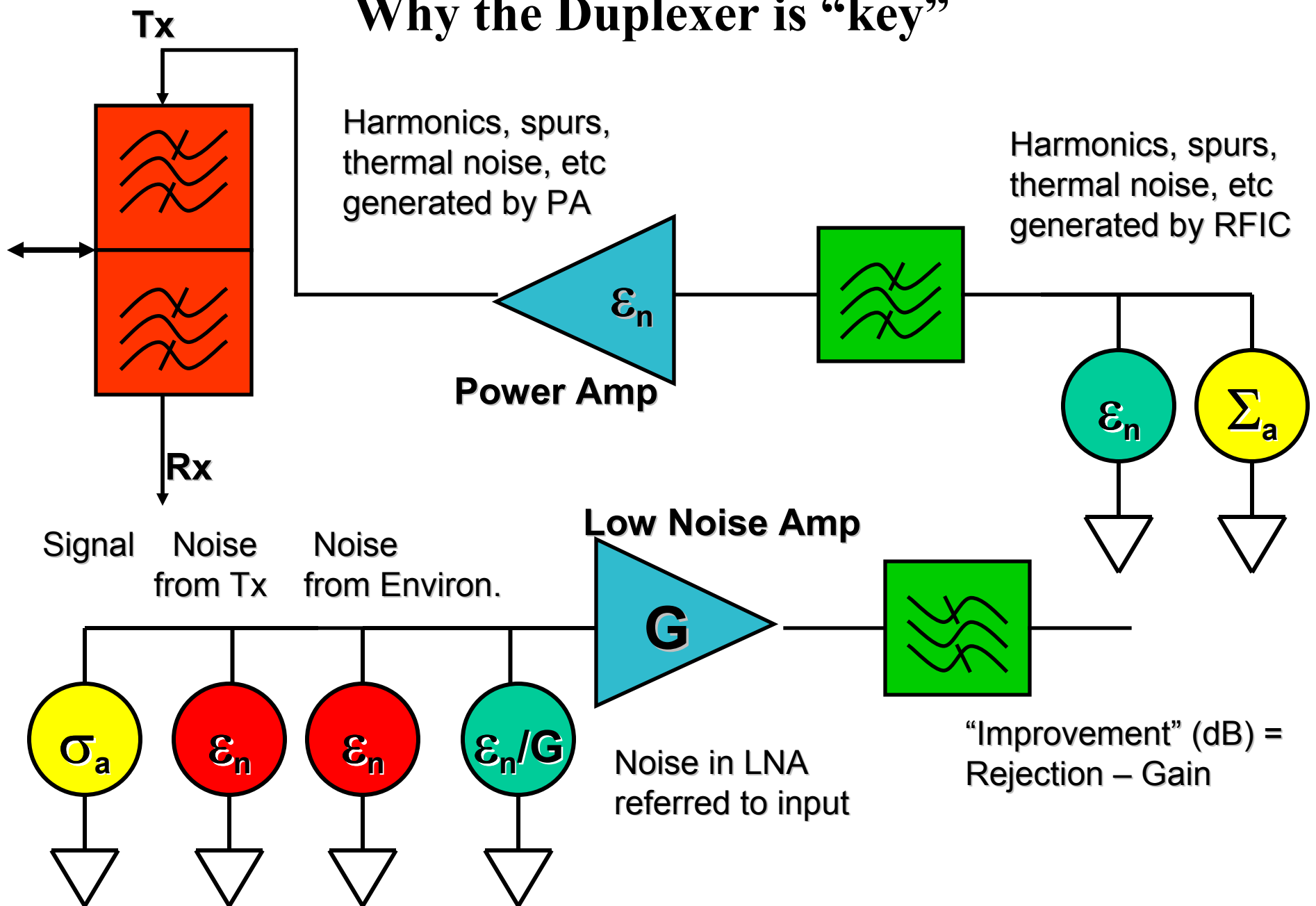
Duplexer Comments

- The most “dramatic” impact to CDMA wireless radio will be made by the duplexer!
- Duplexer performance will drive handset performance and allow for future features such as
 1. Concurrent GPS
 2. Intennas (internal Antennas)
 3. G-Block & H-Block Bands (1910 to 1915 and 1915 to 1920 MHz)
- Duplexer more directly influences “Talk Time” and therefore battery life of handset

Compare “talk time” for a phone (given in hours) vs. “standby time” (given in days or weeks)

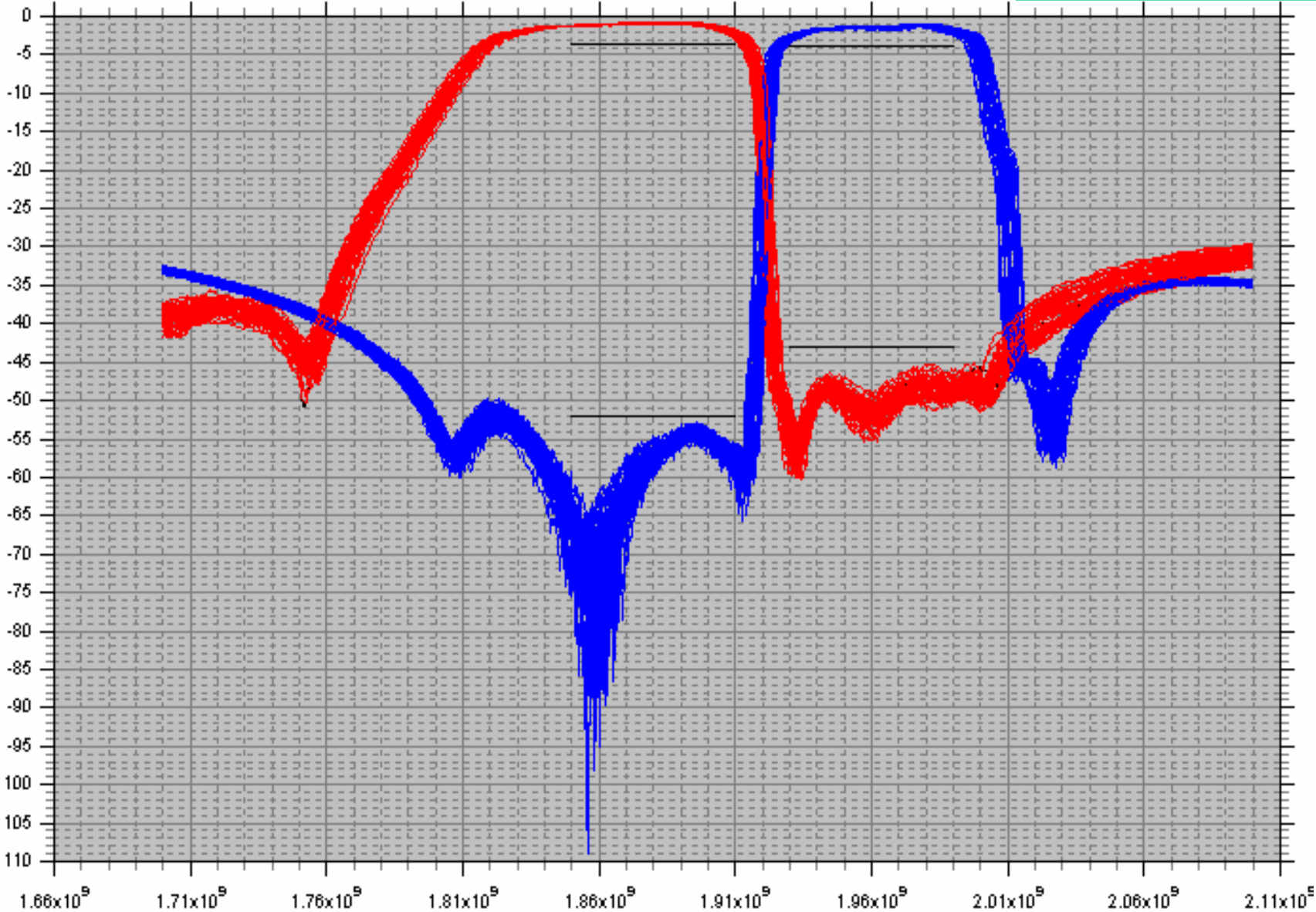
- A “superb” duplexer may remove the need for “point” filters, but, “superb” point filters will never remove the need for a good duplexer!

Why the Duplexer is "key"

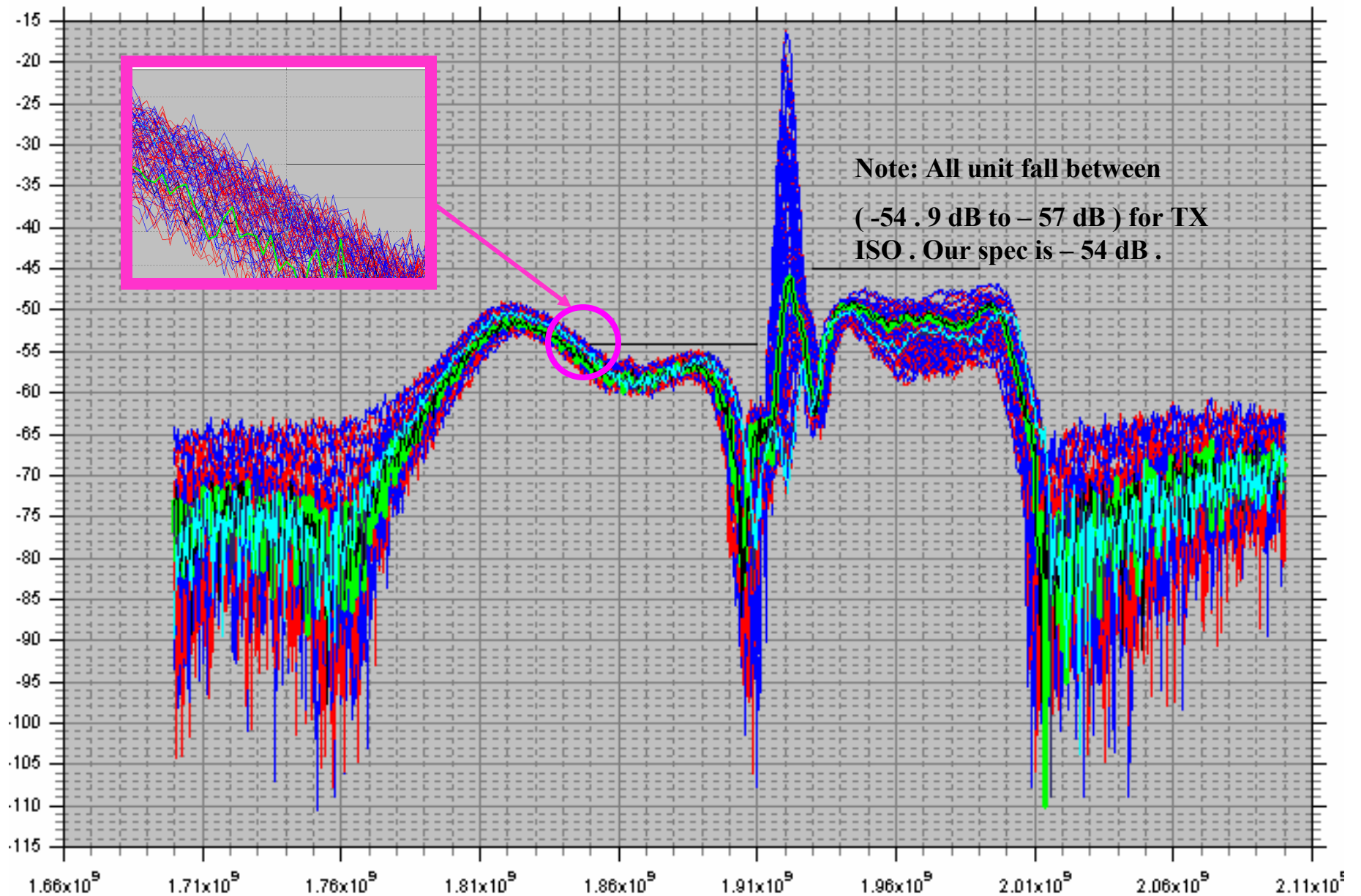


160 3.8X3.8mm PCS Duplexers

For this build, Tx and Rx dice was randomly selected



160 3.8X3.8mm PCS Duplexers – Isolation



Where will the CDMA “point” filter ultimately end up?

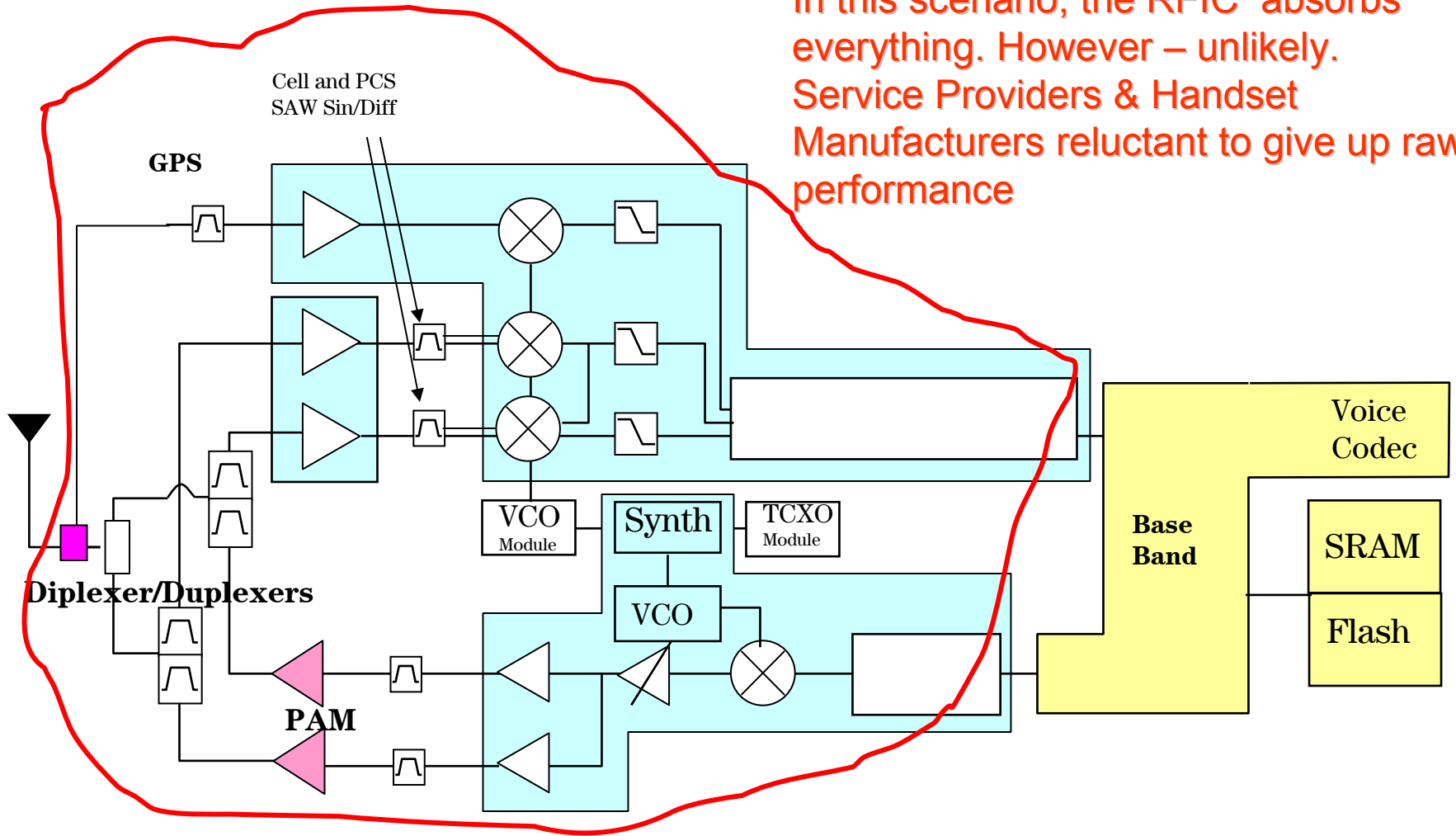
Three Possibilities: Front End Module (FEM), RFIC, Nowhere

- Starting to see papers on integration of BAW with CMOS (Infineon, IMS 2004, ST @ the GSM Congress 2004, LETI presentation at ISSCC feb. '05)
- Could put microcap'd FBAR filters directly on CMOS die

VS.

- One customer has FEM requirement that “point” filter be in FEM
- But, majority of customers say,
“Fine, if point filter is in FEM, but, don't expect us to pay more”
- “By-Band” Power module with FBAR duplexer (in production by Agilent)

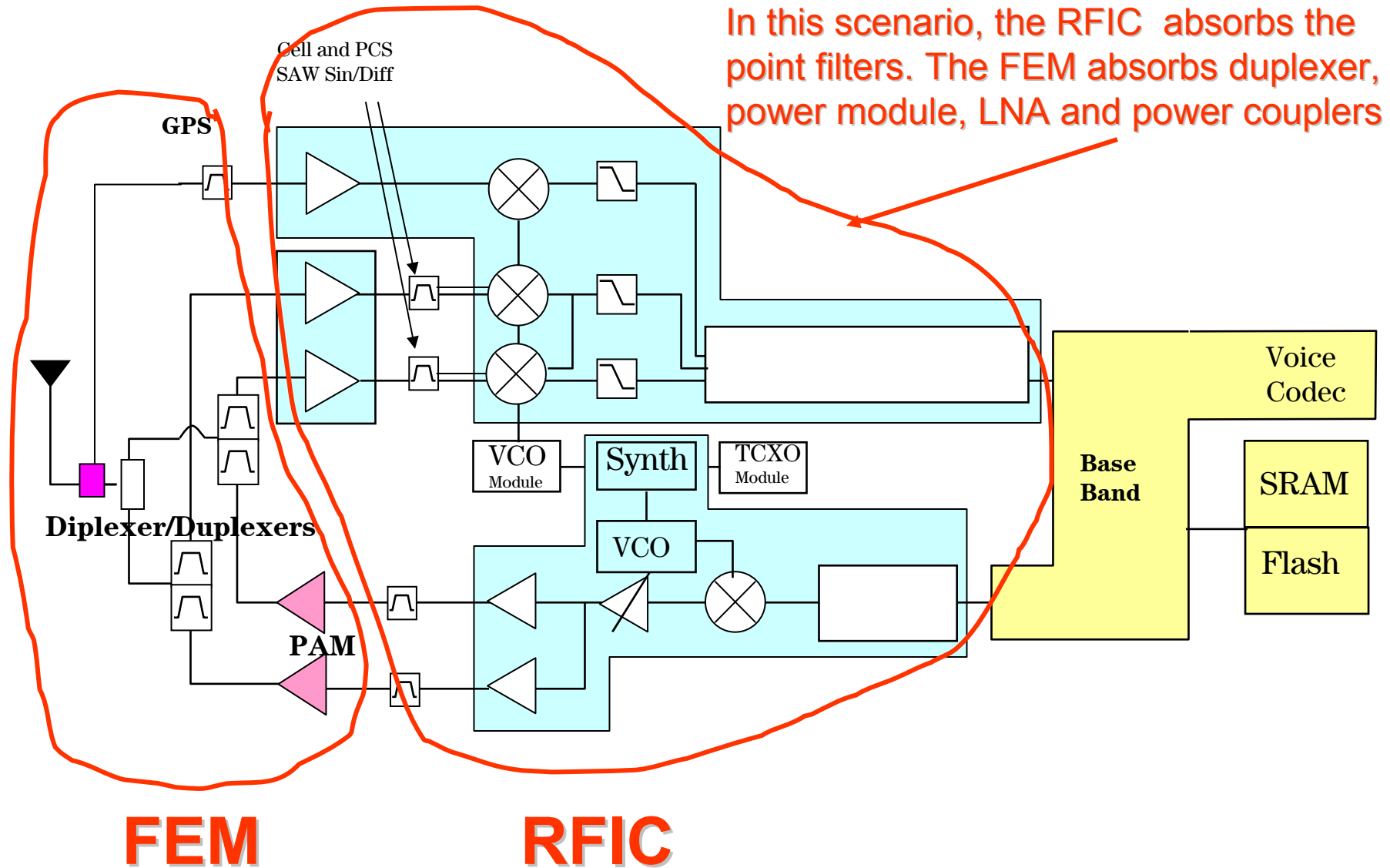
CDMA Block Diagram



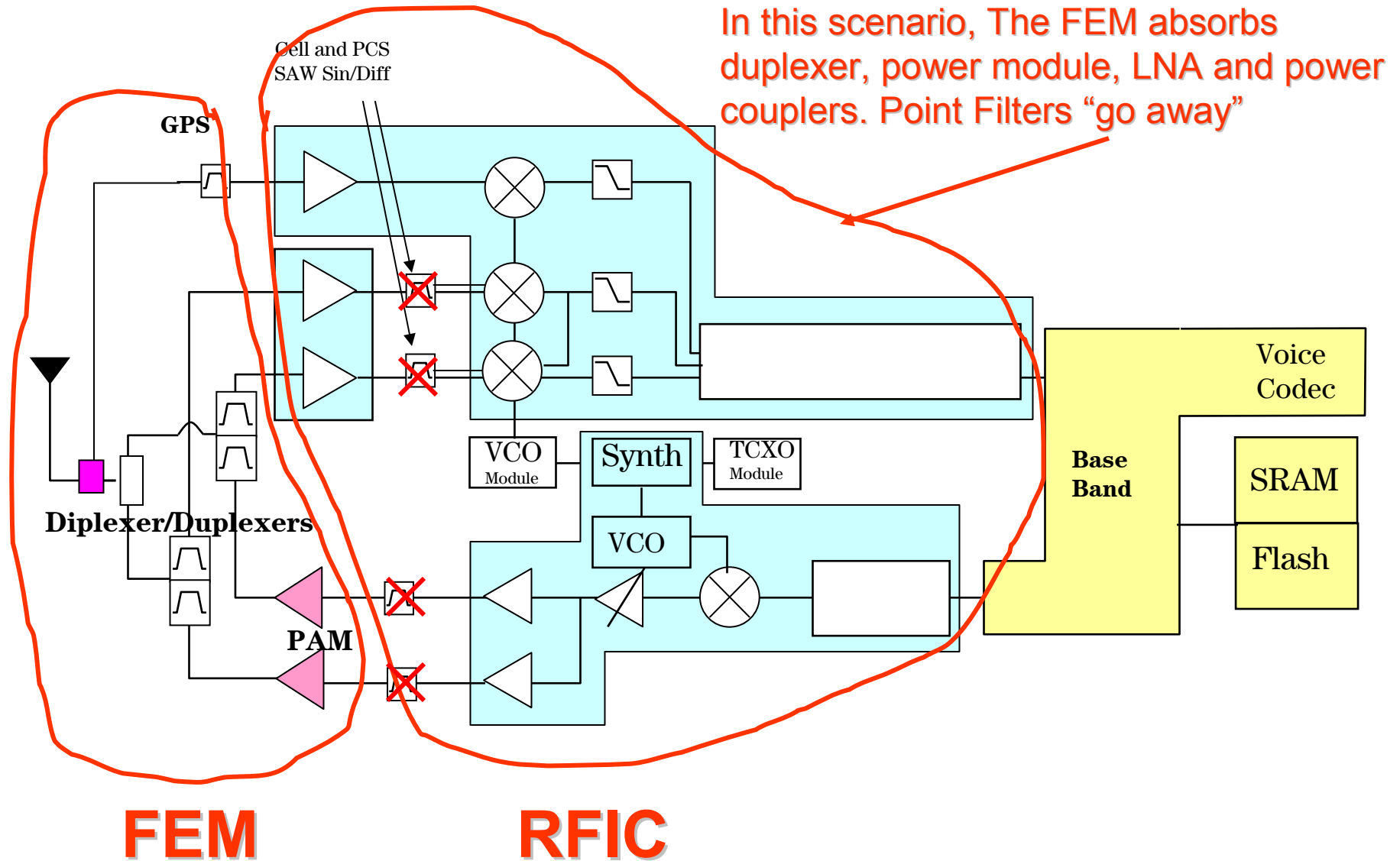
In this scenario, the RFIC absorbs everything. However – unlikely. Service Providers & Handset Manufacturers reluctant to give up raw performance

RFIC

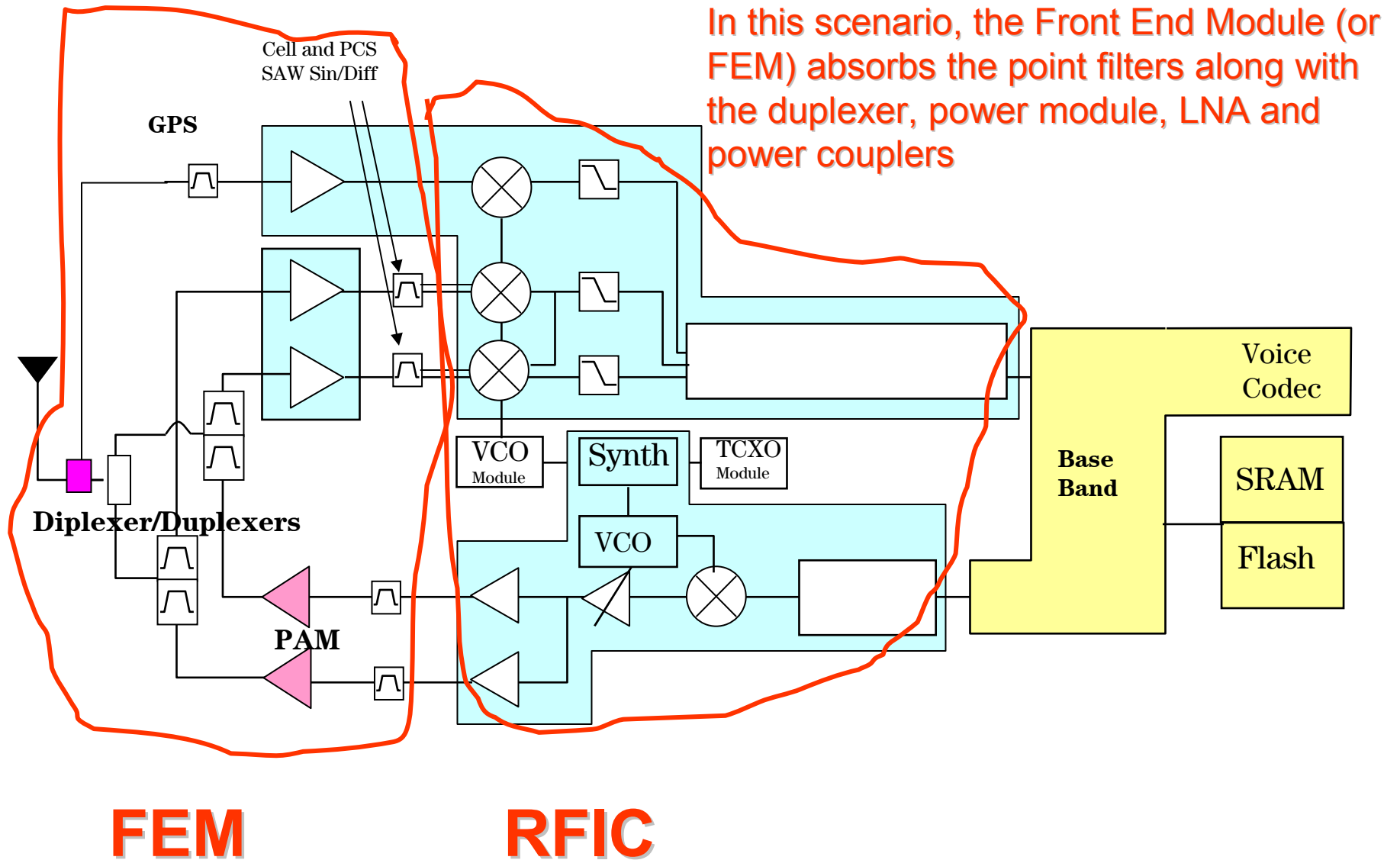
CDMA Block Diagram



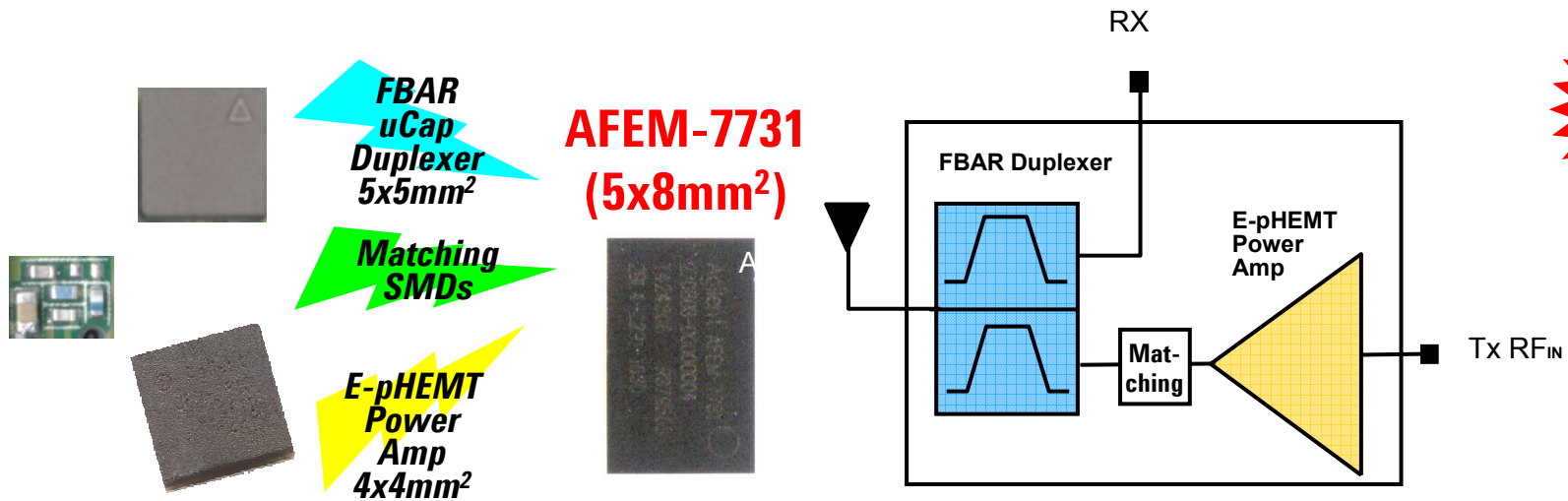
CDMA Block Diagram



CDMA Block Diagram



Agilent CDMA Front-End Module



- Combines **Best-In-Class** CDMA PA and Duplexer with optimized interface
- **Smaller Size** (up to 50% board space savings)
- **Reduced Part Count** (up to 65% parts count reduction, including passives)
- Enhanced Radio Performance with guaranteed system level specs
 - **High Effective PAE**, which includes duplexer and matching loss
 - Low “Full-Duplex NF” for high sensitivity
 - Low “Tx Power at Rx” for STD test
- Excellent Low Voltage Performance for DC-DC Converter operation
- **Less susceptible to Interference** because the signal trace and reference ground plan are contained in the module.
- Bulky and costly **isolator is eliminated**

To Date: 39 Phone Design Wins



Conclusions

- Commercially, there are two major markets for SAW/BAW/FBAR;

Duplexer and “Other”

- PCS, WCDMA duplexers dominated (or soon will be) by FBAR
Cell Band Duplexer & GSM “point” filters dominated by SAW
- The most “dramatic” impact to CDMA wireless radio will be made by the duplexer!
- Duplexer performance will drive handset performance and allow for future features such as
 1. Concurrent GPS
 2. Intennas (internal Antennas)
 3. G-Block & H-Block Bands (1910 to 1915 and 1915 to 1920 MHz)
- Duplexer influences “Talk Time” and therefore battery life of handset via Tx insertion loss
- Duplexer influences the effective range of base stations via the Rx insertion loss